



Gr 1755

Docket No. 56629 (71987)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

APPLICANT: K. Hwang et al.

U.S.S.N.: 09/982,493

GROUP: Unknown

FILED: October 18, 2001

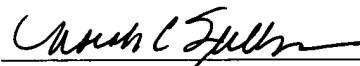
EXAMINER: Unknown

FOR: AMINO RESIN COMPOSITION FOR MOLD CLEANING

CERTIFICATE OF MAILING

I hereby certify that this paper (along with any paper referred to as being attached or enclosed) is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to the Assistant Commissioner for Patents, Washington, DC, 20231 on December 5, 2001.

By:


Norah C. Sullivan

Assistant Commissioner for Patents
Washington, D.C. 20231

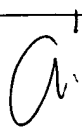
Sir:

PRELIMINARY AMENDMENT


Applicants kindly request that the above-identified application be amended as follows:

IN THE SPECIFICATION

On page 3, line 4, please amend the paragraph as follows:

 --The amino resin used in the invention is a general amino resin such as melamine and the like.--

On page 3, lines 5-20, please amend the paragraph as follows:

 --The specifically-made semi-cured amino resin and a semi-cured mixture thereof used in the invention contains at least one methylol group, for example, melamine-form aldehyde resin, melamine-phenol-formaldehyde resin, melamine-urea-formaldehyde resin, urea-formaldehyde,

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